

Electronic Acknowledgement Receipt

EFS ID:	1048162
Application Number:	10766746
Confirmation Number:	2840
Title of Invention:	Strip-fabricated flip chip in package and flip chip in system heat spreader assemblies and fabrication methods therefor
First Named Inventor:	Tie Wang
Customer Number:	22898
Filer:	Mikio Ishimaru/Vickie Ishimaru
Filer Authorized By:	Mikio Ishimaru
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File Listing:

Document Number	Document Description	File Name	File Size(Bytes)	Multi Part	Pages
1		27-013_Amendment_AF.pdf	1106528	yes	21

	Multipart Description		
	Doc Desc	Start	End
	Amendment After Final	1	5
	Applicant Arguments/Remarks Made in an Amendment	6	21
Warnings:			
Information:			
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<p>This Acknowledgement Receipt evidences receipt on the noted date by the USPTO of the indicated documents, characterized by the applicant, and including page counts, where applicable. It serves as evidence of receipt similar to a Post Card, as described in MPEP 503.</p> <p><u>New Applications Under 35 U.S.C. 111</u> If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.</p> <p><u>National Stage of an International Application under 35 U.S.C. 371</u> If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.</p>			